## **IE09150PC**



## **Product Features**

- 900 ~ 930MHz (ISM band)
- 160W CW Peak Power @ 50V
- 82% Drain Efficiency @ 50V
- Excellent Ruggedness
- Excellent Thermal Stability
- Internally Matched

### Applications

- Industrial Heating and Drying
- Scientific
- Medical : Skin Treatment, Blood Therapy
- Plasma Lighting



Package Type : NS-AS01

### Description

The 150W CW RF Power Transistor is designed for Industrial, Scientific, Medical (ISM) and Plasma Lighting applications at 915MHz. This device is suitable for use in CW, pulse and linear applications. This high efficiency rugged device is targeted to replace Industrial magnetrons and other vacuum tubes currently powering industrial heating, drying, plasma lighting and medical systems.

#### **Typical CW Peak Power Performance** (V<sub>DS</sub>=+50V, Tc=25°C, 50Ω)

Frequency [MHz]	Frequency [MHz] Signal Type		Power Gain [dB]	Drain Efficiency [%]	Pout [W]
910		2.8	17.8	82.72	170
915	CW	2.8	17.6	83.11	167.8
920		2.7	17.7	82.79	163.3

## **Absolute Maximum Ratings**

Rating	Symbol	Value	Unit	Condition			
Drain to Source Voltage	V <sub>DSS</sub>	150	V	Tc=25°C			
Gate to Source Voltage	V <sub>GS</sub>	-10, +2	v	Tc=25°C			
<b>Operating Voltage</b>	V <sub>DD</sub>	52	V <sub>DC</sub>	-			
Maximum Forward Gate Current	Igmax	24	mA	Tc=25°C			
Maximum Drain Current*1	I <sub>DMAX</sub>	9	А	Tc=25°C			
<b>Power Dissipation</b>	P <sub>DISS</sub>	90.5	W	Tc=85°C			
Storage Temperature	T <sub>STG</sub>	-65, +150	°C	-			
Case Operating Temperature	Tc	-40, +150	°C	-			
<b>Operating Junction Temperature</b> *2	τJ	225	°C	-			
Soldering Temperature*3	Ts	245	°C	-			

Note

\*1 Current Limit for long term, reliable operation.

\*2 Continuous use at maximum temperature will affect MTTF.

\*3 Refer to the Application Note(AN-002) on soldering - "Solder Condition for RFHIC's GaN Device"

## **Thermal Characteristics**

Rating	Symbol	Value	Unit	Condition
Thermal Resistance, Junction to Case	$R_{ heta JC}$	1.54 <b>*1</b>	°C/W	Tc=85°C

Note

\*1 Measured for the IE24150P at dissipation power is 90.5W



Characteristics	Conditions	Symbol	Min	Тур	Max	Unit		
DC Characteristics <sup>*1</sup>								
Gate Threshold Voltage	$V_{DS} = 10V$	17	-3.8	-3.0	-2.3	V <sub>DC</sub>		
Gate Threshold Voltage	$I_D = 21.6 \mathrm{mA}$	V <sub>GS(TH)</sub>		-5.0				
Gate Quiescent Voltage	$V_{DS} = 50V$	V <sub>GS(Q)</sub>		-3.2	_	V <sub>DC</sub>		
Gatt Quitstein Vonage	$I_D = 50 m A$	V GS(Q)	-	-3.2	_	V DC		
Saturated Drain Current <sup>*2</sup>	$V_{\rm DS} = 6V$	I <sub>DS</sub>	18.0	21.6	-	А		
	$V_{GS} = 2V$	103						
Drain-Source Breakdown Voltage	$V_{GS} = -8V$	$V_{BR}$	150			v		
	$I_D = 21.6 \mathrm{mA}$	, pr	100			·		
Gate Leakage Current	$V_{GS} = -8V$	Iglkg	-4.8	-		mA		
oute Zouninge current	$V_{DS} = 120V$	TOLKO						
Drain Leakage Current	$V_{GS} = -8V$	I <sub>DLKG</sub>	_		8.6	mA		
	$V_{DS} = 120V$							
	RF Characteristic	cs $(Fc = 2450)$	)MHz unless	otherwise note	d)			
Saturated Output Power <sup>*3</sup>	$V_{DS} = 50V$	Psat	150	160		W		
Saturated Output rower	$I_{DQ} = 50 mA$	1 5A1	150	100	-	vv		
	$V_{DS} = 50V$							
CW Drain Efficiency*3	$I_{DQ} = 50 mA$	η	79	82	-	%		
	$P_{OUT} = P_{SAT} CW$			om				

## Electrical Characteristics (Tc=25°C unless otherwise noted)

Note \*1 Measured on wafer prior to packaging.

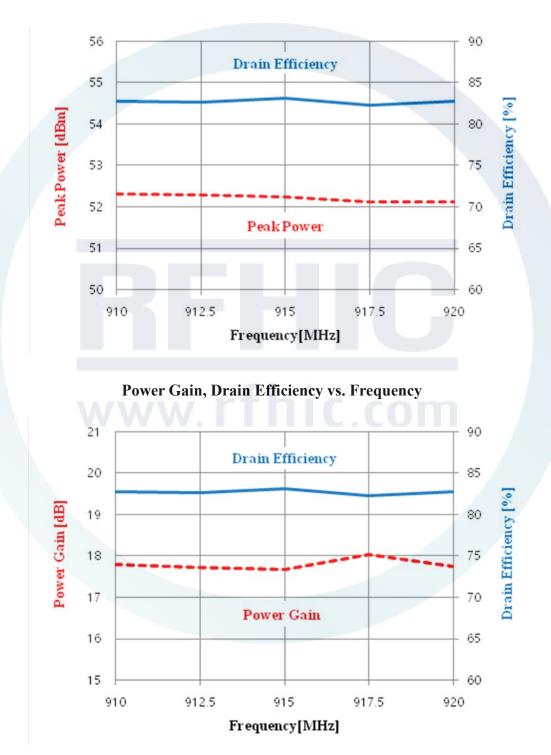
\*2 Scaled from PCM data.

\*3 CW(Continuous Wave) signal operation condition.

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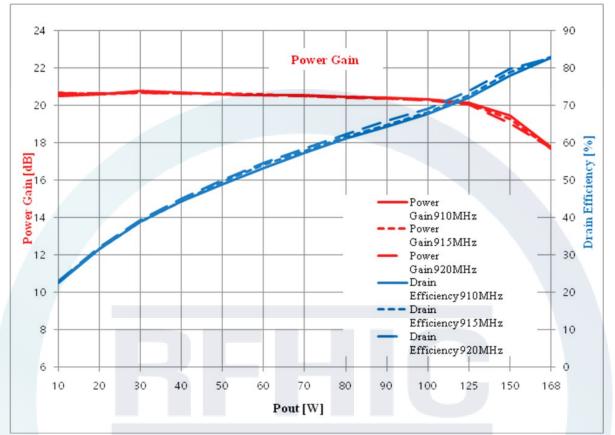
## **Typical CW Performance Charts**

\* Bias condition  $(I_{DQ}=50mA @ V_{DS}=50V, Tc=25^{\circ}C)$ 



## Peak Power, Drain Efficiency vs. Frequency

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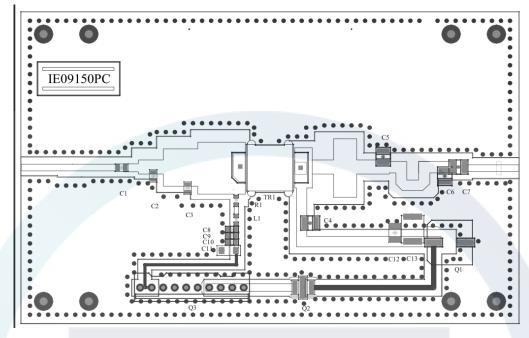


Power Gain, Drain Efficiency vs. Output Power

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## **Application Circuit**



## Part List

Part	Description	Part Number	Manufacturer	
L1	18nH Chip Inductor	LL1608-FSL18NJ	ТОКО	
R1	10 Ohm Chip Resistor, 2012	MCR10EZHJ100	ROHM	
C1	100pF High Q Capacitor	201 CHA 101 JSLE	TEMEX	
C2	6.8pF High Q Capacitor	201 CHA 6R8 CSLE	TEMEX	
C3	2.7 pF High Q Capacitor	201 CHA 2R7 CSLE	TEMEX	
C4, C12	100pF High Q Capacitor	501 CHB 101 JSLE	TEMEX	
C5	2.7pF High Q Capacitor	501 CHB 2R7 CSLE	TEMEX	
C6	0.9 pF High Q Capacitor	501 CHB 0R9 BSLE	TEMEX	
C7	5.6 pF High Q Capacitor	501 CHB 5R6 CSLE	TEMEX	
C8	100pF Chip Capacitor	GRM1885C1H101JA01D	MURATA	
С9	1nF Chip Capacitor	GRM188R71H102KA01D	MURATA	
C10	100nF Chip Capacitor	GRM188R71H104KA93D	MURATA	
C11	10uF, 16V MLCC	C3216X7R1C106K	TDK	
C13	10uF, 100V MLCC	CKG57NX7R2A106MT	TDK	
Q1	33uF Aluminum Capacitor	BDS100VC33MJ10TP	SAMYOUNG	
Q2	EMI FILTER	CTH32R102S20A-TM	MARUWA	
Q3	DC Connector	22-04-1101	MOLEX	
РСВ	εr=3.5 ± 0.05, 0.030" (0.762mm)	RF-35TC	TACONIC.	
TR1	150W GaN Transistor	IE09150PC	RFHIC	

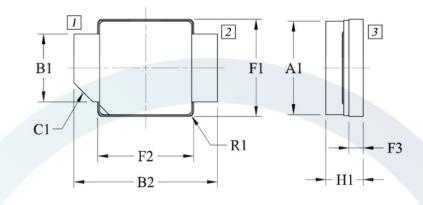
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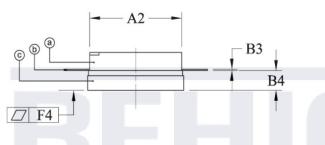
**IE09150PC** 

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## Package Dimensions (Type: NS-AS01)

\* Unit: mm[inch] | Tolerance ±0.15 [.006]



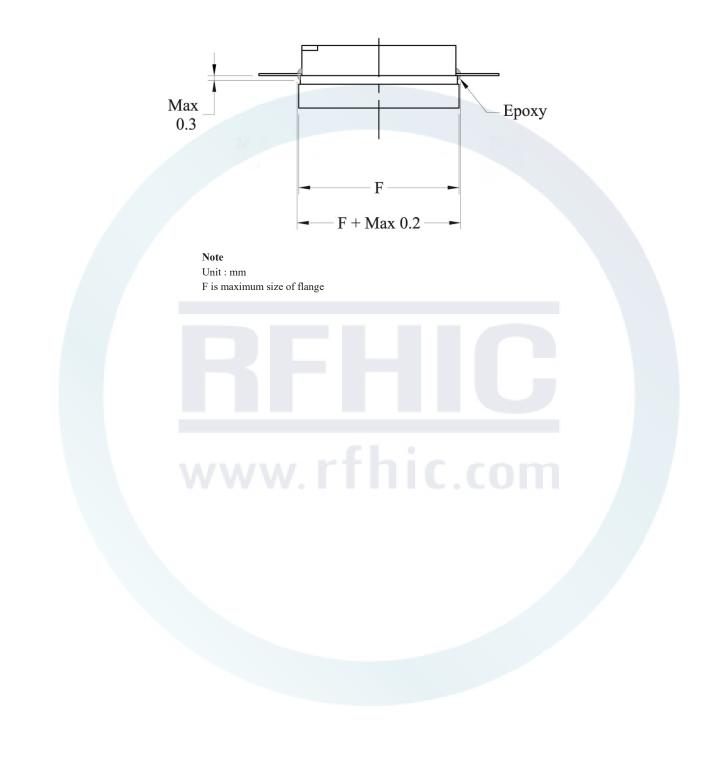


Pin Description			D	INCH			MILLIMETER		
Pin No	Function		Dim.	MIN	ТҮР	MAX	MIN	ТҮР	MAX
I	Gate		A1	.380	.384	.390	9.65	9.75	9.90
2	Drain	W	A2	.380	.384	.390	9.65	9.75	9.90
3	Source		B1	.274	.280	.285	6.97	7.10	7.23
		-	B2	.579	.598	.618	14.70	15.20	15.70
			В3	.004	.005	.007	0.10	0.13	0.18
	@- Lid		B4	.080	.085	.090	2.03	2.15	2.28
	(b)- Lead Frame		C1 (Chamfer)	.075	.079	.083	1.90	2.00	2.10
	©- Flange		F1	.395	.400	.405	10.03	10.16	10.29
			F2	.395	.400	.405	10.03	10.16	10.29
			F3	.054	.059	.064	1.37	1.50	1.63
			F4	-	.001	-	-	0.03	-
			H1	.148	.159	.167	3.75	4.05	4.25
			L1	-	-	-	-	-	-
			L2	-	-	-	-	-	-
			R1 (Radius)	.016	.020	.024	0.40	0.50	0.60

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## **Sealing Epoxy Tolerance** (Type : NS-DS01)





### **Revision History**

Part Number	Release Date	Version	Description	Data Sheet Status
IE09150PC	NOV, 2019	0.2	Modify Frequency	Preliminary
IE09150PC	AGU, 2017	0.1	Initial Release of DataSheet	Preliminary



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